

# Medium Power Transistor (-32V, -1A)

## MP6Z1

### ●Applications

Low frequency amplifier

### ●Features

1) Low  $V_{CE(sat)}$

$$V_{CE(sat)} = -0.2V(\text{Typ.})$$

$$(I_C / I_B = -500mA / -50mA)$$

2) Contains 2SD1664-die and 2SB1132-die in a package.

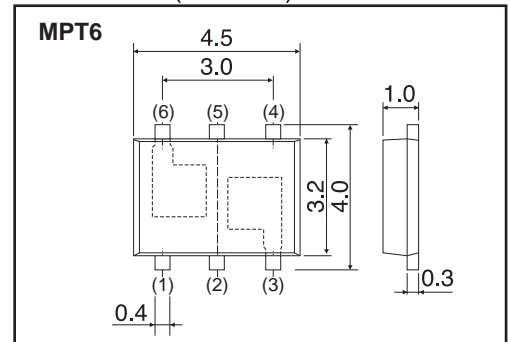
### ●Structure

Silicon epitaxial planar transistor

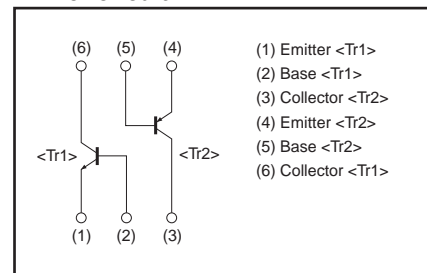
### ●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit(pieces)	1000
MP6Z1		○

### ●Dimensions (Unit : mm)



### ●Inner circuit



### ●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits		Unit	
		Tr1	Tr2		
Collector-base voltage	$V_{CBO}$	40	-40	V	
Collector-emitter voltage	$V_{CEO}$	32	-32	V	
Emitter-base voltage	$V_{EBO}$	5	-5	V	
Collector current	Continuous	$I_C$	1.0	-1.0	A
	Pulsed	$I_{CP}$ *1	2.0	-2.0	A
Power dissipation	$P_D$ *2	2.0		W / TOTAL	
		1.4		W / ELEMENT	
Junction temperature	$T_j$	150		°C	
Range of storage temperature	$T_{stg}$	-55 to 150		°C	

\*1  $P_w=10ms$  1Pulse

\*2 Mounted on a ceramic board

**●Electrical characteristics (Ta=25°C)**

&lt;Tr1&gt;

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	32	–	–	V	I <sub>C</sub> =1mA
Collector-base breakdown voltage	BV <sub>CBO</sub>	40	–	–	V	I <sub>C</sub> =50μA
Emitter-base breakdown voltage	BV <sub>EBO</sub>	5	–	–	V	I <sub>E</sub> =50μA
Collector cut-off current	I <sub>CBO</sub>	–	–	500	nA	V <sub>CB</sub> =20V
Emitter cut-off current	I <sub>EBO</sub>	–	–	500	nA	V <sub>EB</sub> =4V
Collector-emitter saturation voltage	V <sub>CE(sat)</sub> *	–	–	400	mV	I <sub>C</sub> =500mA, I <sub>B</sub> =50mA
DC current gain	h <sub>FE</sub>	120	–	390	–	V <sub>CE</sub> =3V, I <sub>C</sub> =100mA
Transition frequency	f <sub>T</sub> *	–	150	–	MHz	V <sub>CE</sub> =5V, I <sub>E</sub> =–50mA, f=100MHz
Collector output capacitance	C <sub>ob</sub>	–	15	–	pF	V <sub>CB</sub> =10V, I <sub>E</sub> =0A, f=1MHz

\* Pulsed

&lt;Tr2&gt;

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	–32	–	–	V	I <sub>C</sub> = –1mA
Collector-base breakdown voltage	BV <sub>CBO</sub>	–40	–	–	V	I <sub>C</sub> = –50μA
Emitter-base breakdown voltage	BV <sub>EBO</sub>	–5	–	–	V	I <sub>E</sub> = –50μA
Collector cut-off current	I <sub>CBO</sub>	–	–	–500	nA	V <sub>CB</sub> = –20V
Emitter cut-off current	I <sub>EBO</sub>	–	–	–500	nA	V <sub>EB</sub> = –4V
Collector-emitter saturation voltage	V <sub>CE(sat)</sub> *	–	–	–500	mV	I <sub>C</sub> = –500A, I <sub>B</sub> = –50mA
DC current gain	h <sub>FE</sub>	120	–	390	–	V <sub>CE</sub> = –3V, I <sub>C</sub> = –100mA
Transition frequency	f <sub>T</sub> *	–	150	–	MHz	V <sub>CE</sub> = –5V, I <sub>E</sub> =50mA, f=100MHz
Collector output capacitance	C <sub>ob</sub>	–	20	–	pF	V <sub>CB</sub> = –10V, I <sub>E</sub> =0A, f=1MHz

\* Pulsed

●Electrical characteristics curves  
<Tr1>

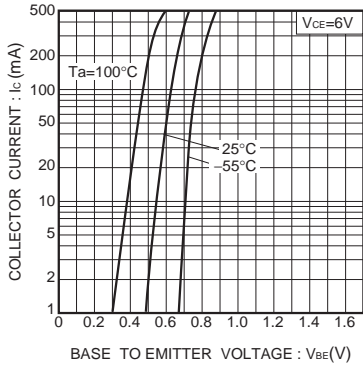


Fig.1 Grounded emitter propagation characteristics

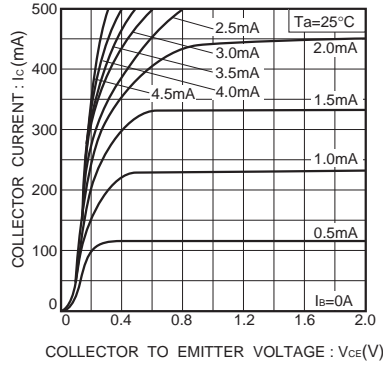


Fig.2 Grounded emitter output characteristics

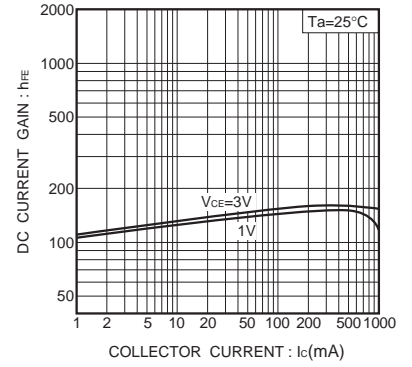


Fig.3 DC current gain vs. collector current ( I )

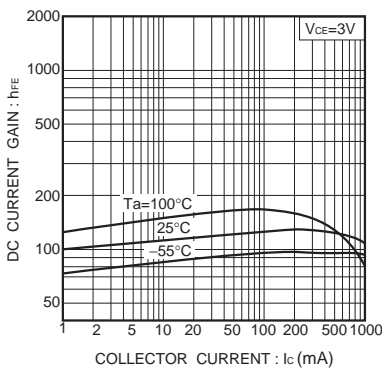


Fig.4 DC current gain vs. collector current (II)

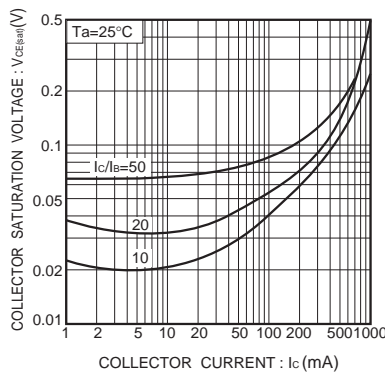


Fig.5 Collector-emitter saturation voltage vs. collector current ( I )

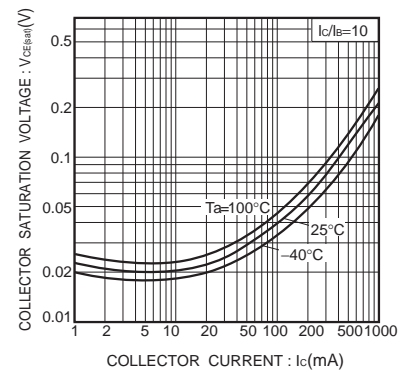


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

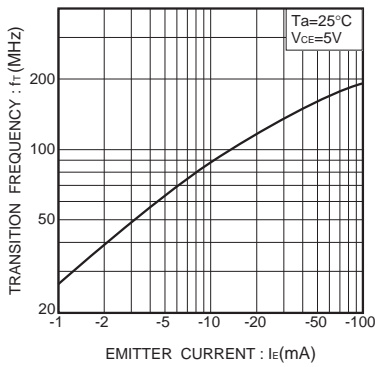


Fig.7 Gain bandwidth product vs. emitter current

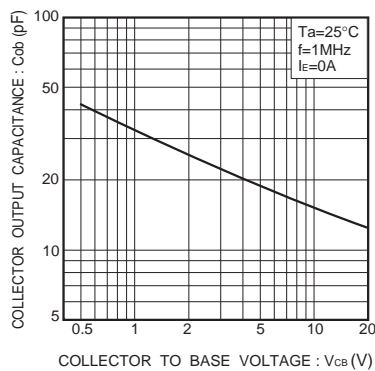


Fig.8 Collector output capacitance vs. collector-base voltage

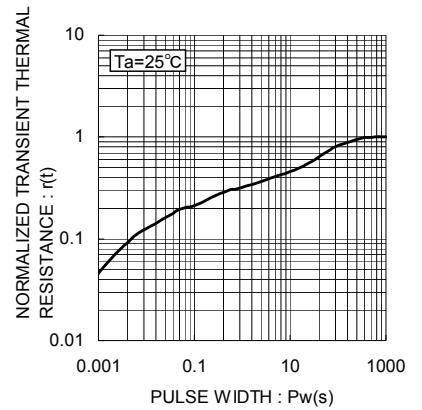


Fig.9 Normalized thermal resistance (Element)

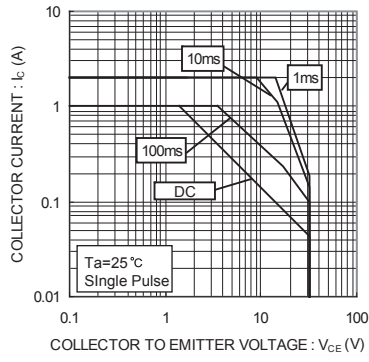


Fig.10 Safe operating area

●Electrical characteristics curves  
<Tr2>

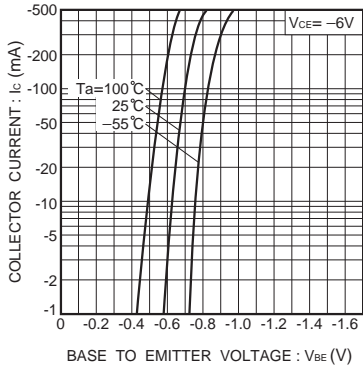


Fig.1 Grounded emitter propagation characteristics

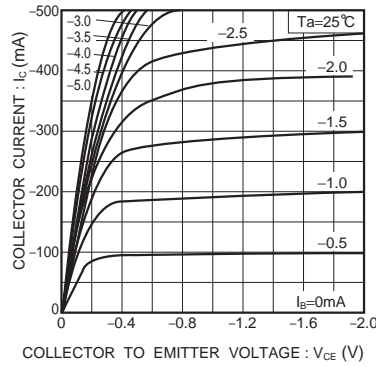


Fig.2 Grounded emitter output characteristics

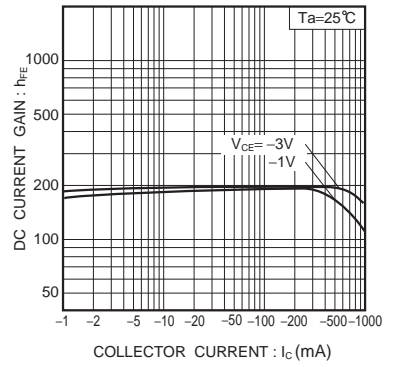


Fig.3 DC current gain vs. collector current(I)

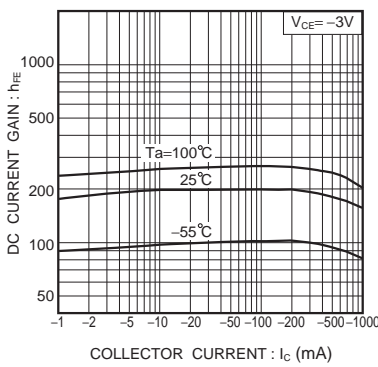


Fig.4 DC current gain vs. collector current(II)

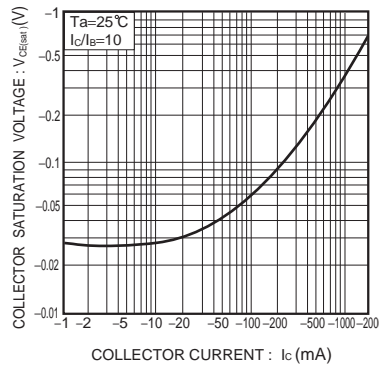


Fig.5 Collector-emitter saturation voltage vs. collector current

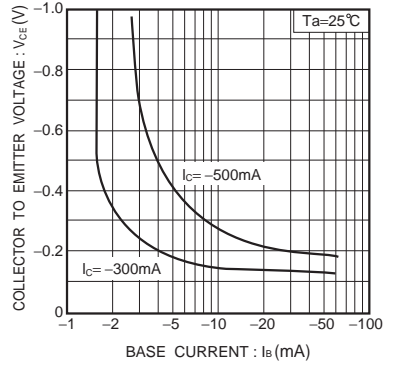


Fig.6 Collector-emitter saturation voltage vs. base current

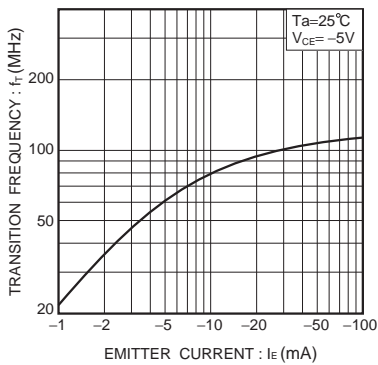


Fig.7 Gain bandwidth product vs. emitter current

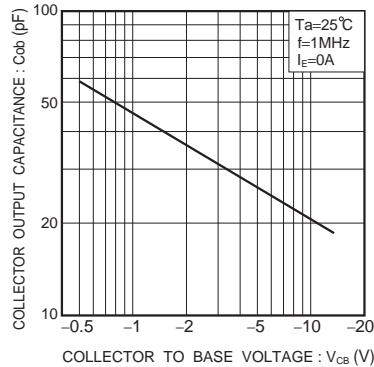


Fig.8 Collector output capacitance vs. collector-base voltage

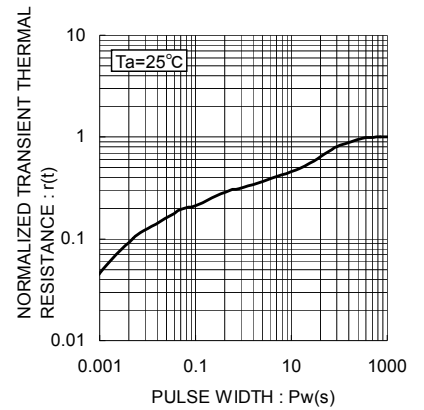


Fig.9 Normalized thermal resistance (Element)

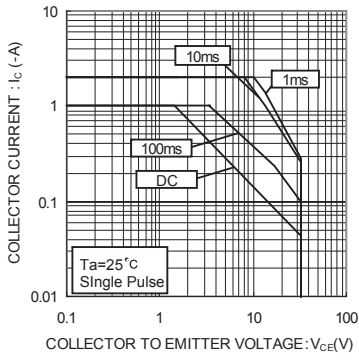


Fig.10 Safe operating area

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